

TJ20A10M3-VB Datasheet P-Channel 100 V (D-S) 175 °C MOSFET

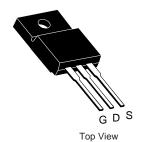
PRODUCT SUMMARY				
V _{DS} (V)	- 100			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -10 \text{ V}$	0.033			
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.037			
I _D (A)	- 50			
Configuration	Single			

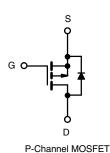
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- Package with Low Thermal Resistance
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC









ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V_{DS}	- 100	V		
Gate-Source Voltage	V _{GS}	± 20			
Continuous Drain Current	T _C = 25 °C	1	- 50		
Continuous Drain Current	T _C = 125 °C	l _D	- 30		
Continuous Source Current (Diode Conduction) ^a	I _S	- 50	Α		
Pulsed Drain Current ^b	I _{DM}	- 180			
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	- 44		
Single Pulse Avalanche Energy	1 L = 0.1 MH	E _{AS}	96	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	P _D	68	W	
	T _C = 125 °C		35	VV	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to + 175	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-Ambient	PCB Mount ^c	R_{thJA}	50	°C/W		
nction-to-Case (Drain)		R _{thJC}	1.1	C/ VV		

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.

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SPECIFICATIONS (T _C = 25 °C,		-	T COMPLETIONS	MIN.			
PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static	T				T	T	1
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		- 100 - 1.0	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}		$V_{DS} = V_{GS}, I_D = -250 \mu A$		-	-2.5	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = - 100 V	-	-	- 1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = -100 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	-	-	- 50	
		$V_{GS} = 0 V$	$V_{DS} = -100 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$	-	-	- 250	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = - 10 V	$V_{DS} \le -5 \text{ V}$	- 30	-	-	Α
		$V_{GS} = -10 \text{ V}$	$I_D = -9.2 \text{ A}$	ı	0.033	-	Ω
Dunin Course On Ctate Presistance	R _{DS(on)}	$V_{GS} = -10 \text{ V}$	I _D = - 9.2 A, T _J = 125 °C	ı	0.074	-	
Drain-Source On-State Resistance ^a	TDS(on)	V _{GS} = - 10 V	I _D = - 9.2 A, T _J = 175 °C	ı	0.093	-	
		$V_{GS} = -4.5 \text{ V}$	I _D = - 7.7 A	-	0.037	-	
Forward Transconductance ^b	9 _{fs}	V _{DS} = - 15 V, I _D = - 9.2 A		-	35	-	S
Dynamic ^b							
Input Capacitance	C _{iss}		= 0 V V _{DS} = - 25 V, f = 1 MHz	-	4433	5545	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$		-	301	380	
Reverse Transfer Capacitance	C _{rss}			-	208	260	
Total Gate Charge ^c	Qg			-	96	144	nC
Gate-Source Charge ^c	Q _{gs}	V _{GS} = - 10 V	$V_{DS} = -50V, I_{D} = -9.2 A$	1	8.4	-	
Gate-Drain Charge ^c	Q _{gd}				23.5	-]
Gate Resistance	R_g	f = 1 MHz		1.5	3.13	4.7	Ω
Turn-On Delay Time ^c	t _{d(on)}	V_{DD} = - 50 V, R_{L} = 6.49 Ω I_{D} \cong - 7.7 A, V_{GEN} = - 10 V, R_{g} = 1.0 Ω		-	11	17	
Rise Time ^c	t _r			-	11	17	- ns
Turn-Off Delay Time ^c	t _{d(off)}			-	78	117	
Fall Time ^c	t _f			-	15	23	
Source-Drain Diode Ratings and Characteristics ^b							
Pulsed Current ^a	I _{SM}			-	-	- 150	Α
Forward Voltage	V _{SD}	I _E = - 7.7 A, V _{GS} = 0 V		-	- 0.8	- 1.5	V

Notes

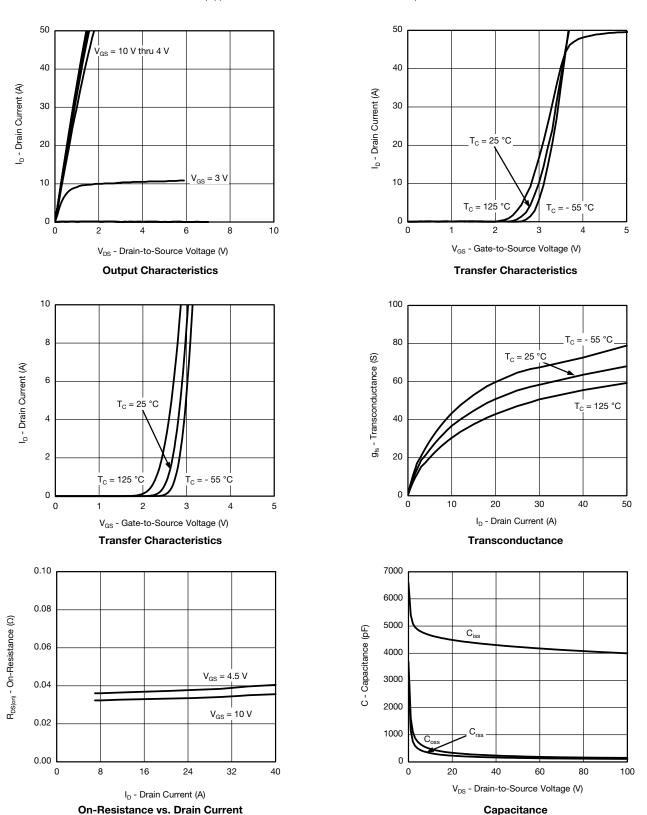
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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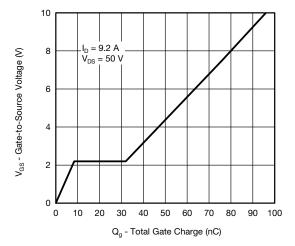


TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

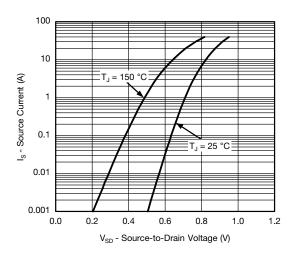




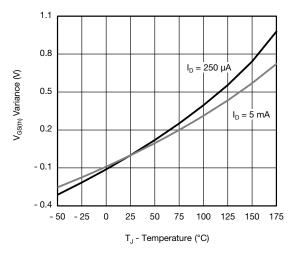
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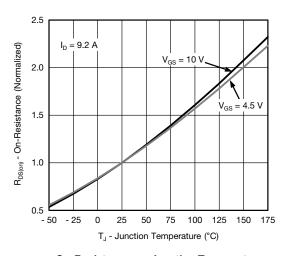
Gate Charge



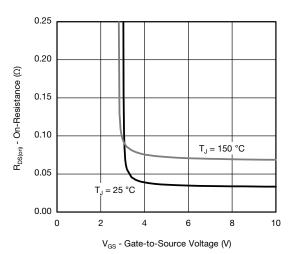
Source Drain Diode Forward Voltage



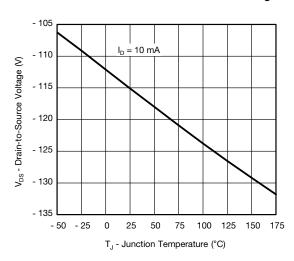
Threshold Voltage



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

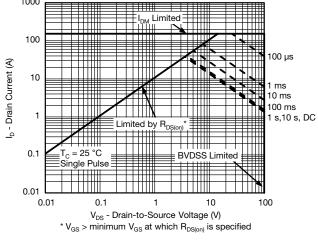


Drain Source Breakdown vs. Junction Temperature

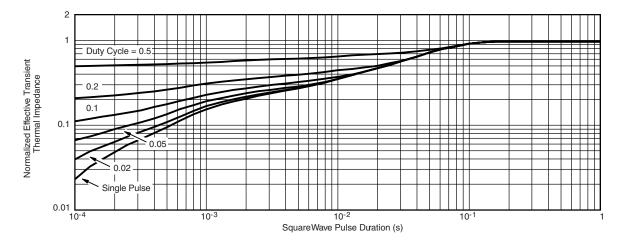
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THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



Safe Operating Area



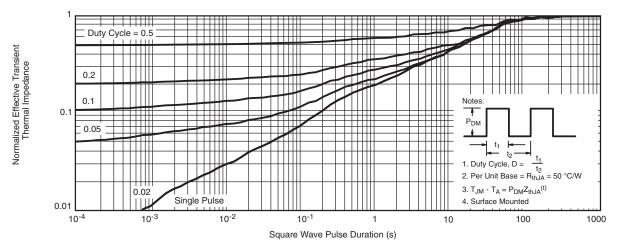
Normalized Thermal Transient Impedance, Junction-to-Case

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

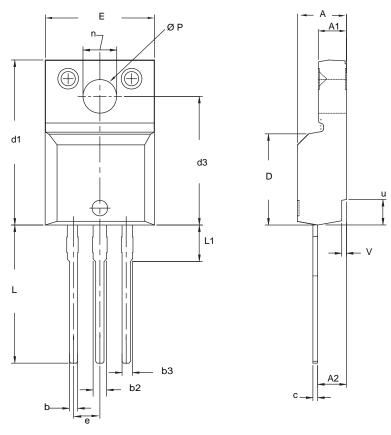
Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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TO-220 FULLPAK



	MILLI	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
A	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54 BSC		0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØΡ	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	
ECN: X09-0126-Rev. B, 2 DWG: 5972	26-Oct-09				

Notes

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
 All dimensions include burrs and plating thickness.
 No chipping or package damage.

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